

2-to-4 decoder

Schematic print

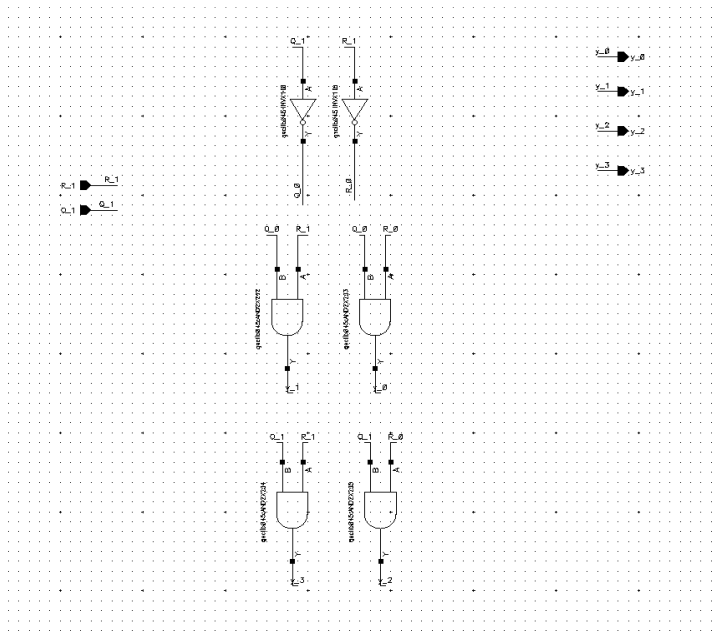


Figure 1: 2-to-4 decoder schematic

Layout print

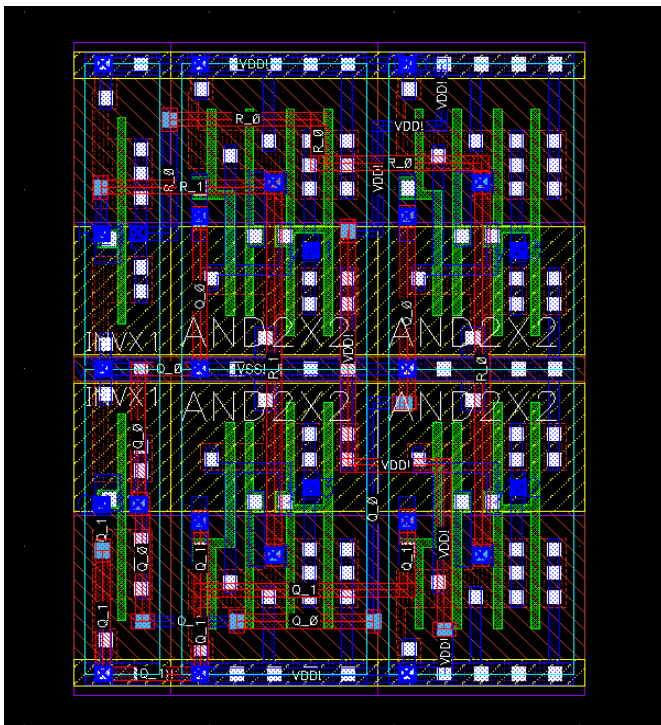


Figure 2: 2-to-4 decoder layout

4-bit 3-input OR

Schematic Print

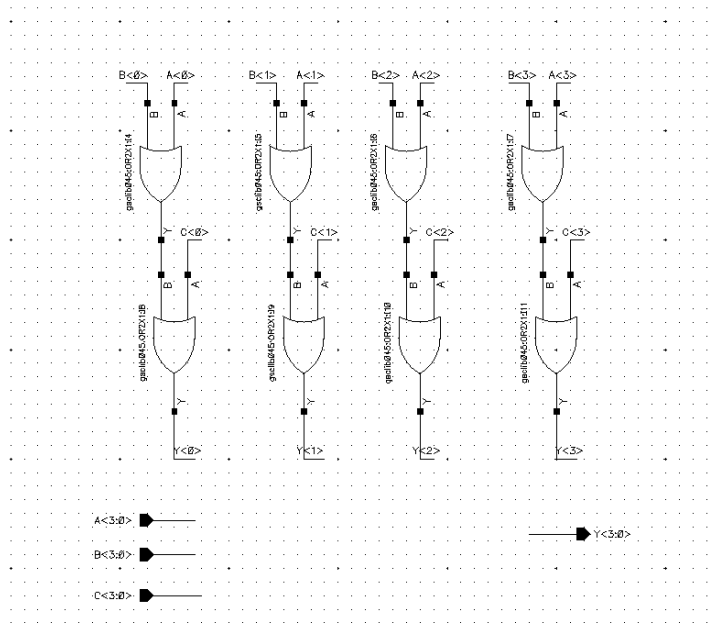


Figure 3: 4-bit 3-input OR schematic

Layout Print

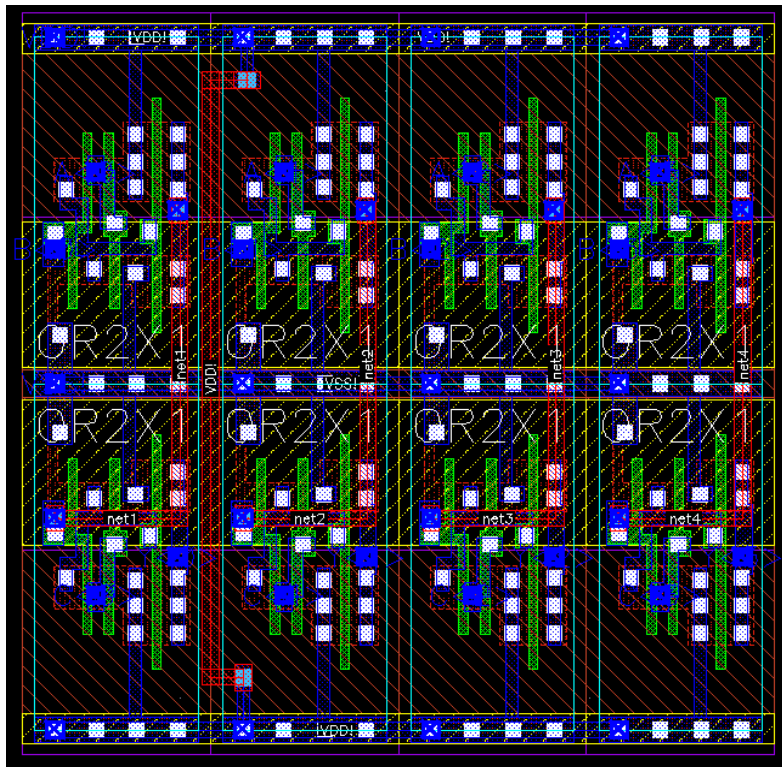


Figure 4: 4-bit 3-input OR layout

4-bit AND

Schematic Print

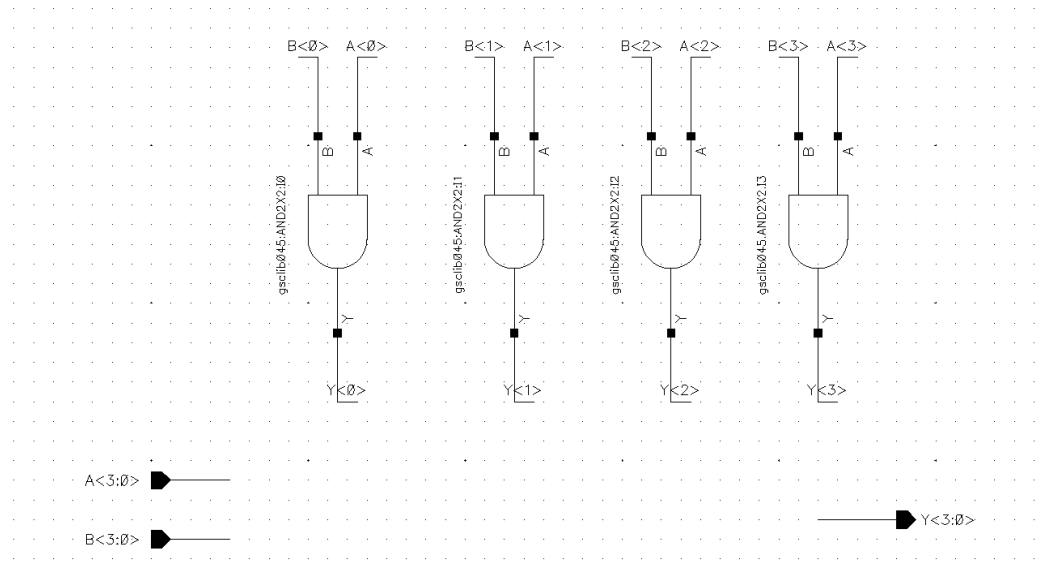


Figure 5: 4-bit AND schematic

Layout Print

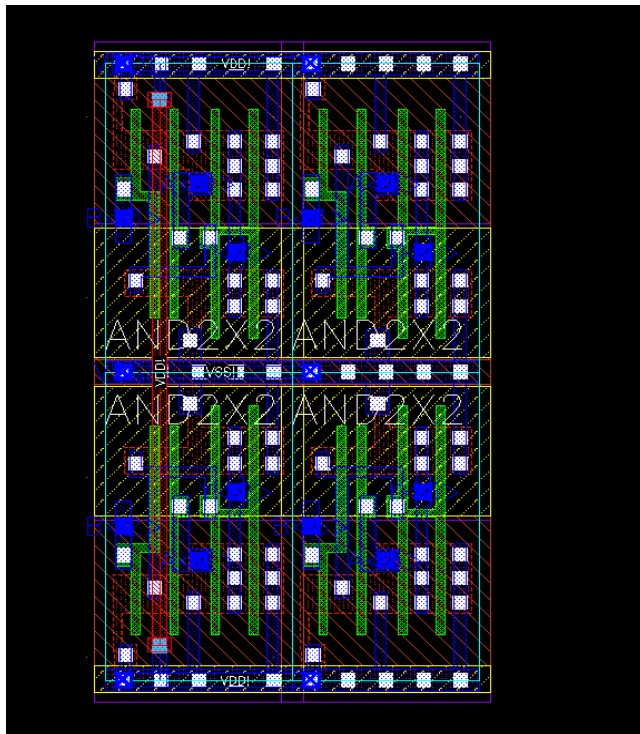


Figure 6: 4-bit AND layout

4-bit MUX

Schematic Print

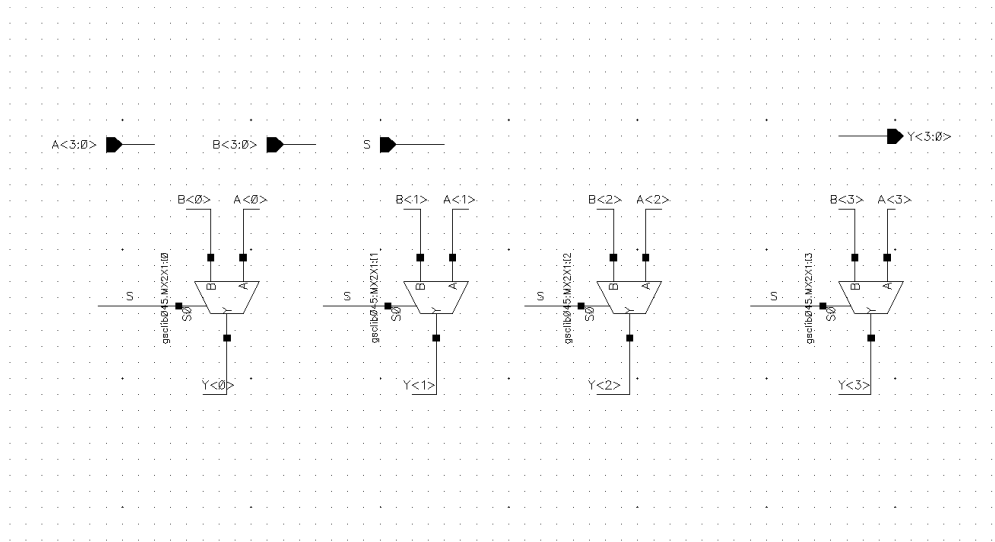


Figure 7: 4-bit MUX schematic

Layout Print

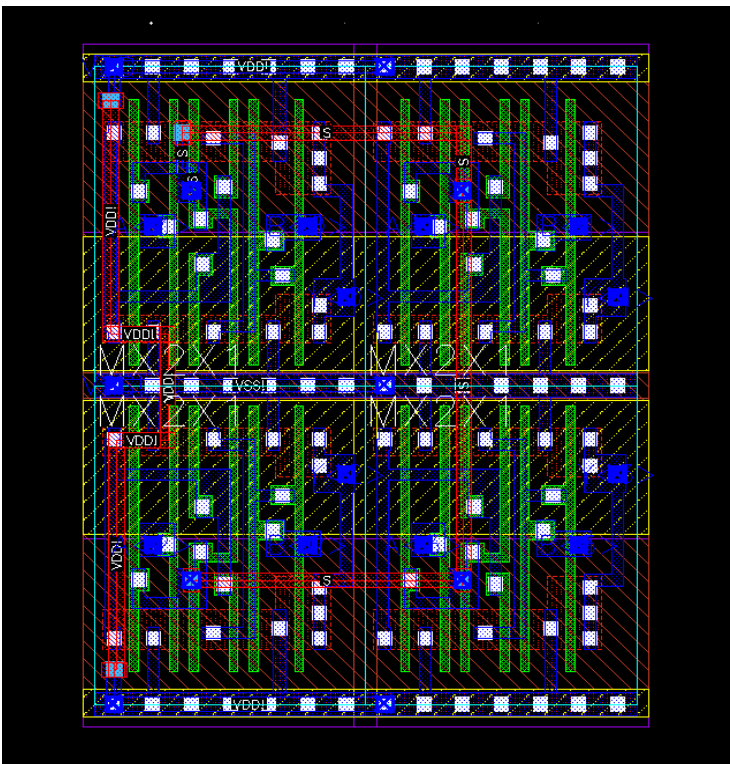


Figure 8: 4-bit MUX layout

4-bit Register

Schematic Print

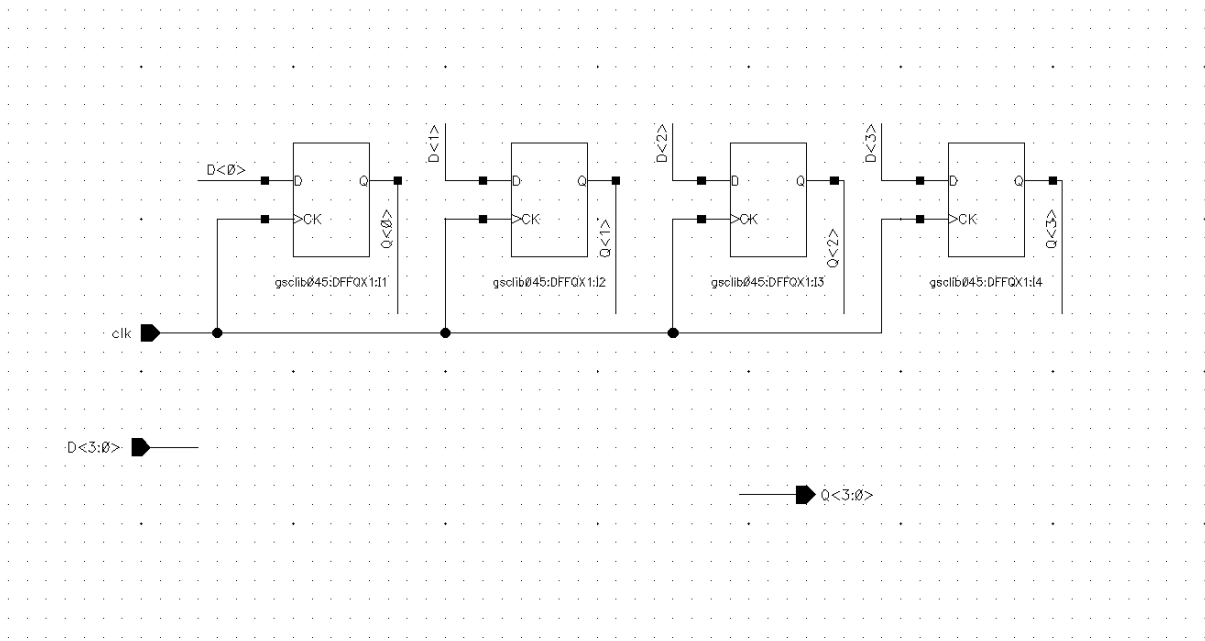


Figure 9: 4-bit register schematic

Layout Print

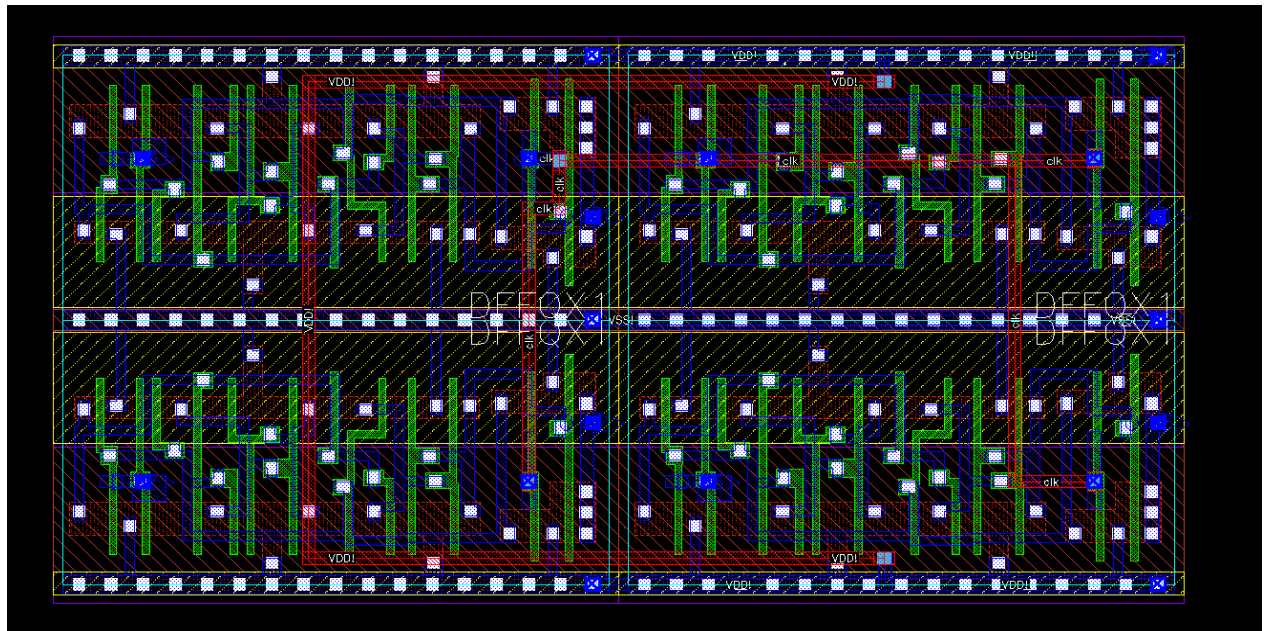


Figure 10: 4-bit register layout

5-bit Register

Schematic Print

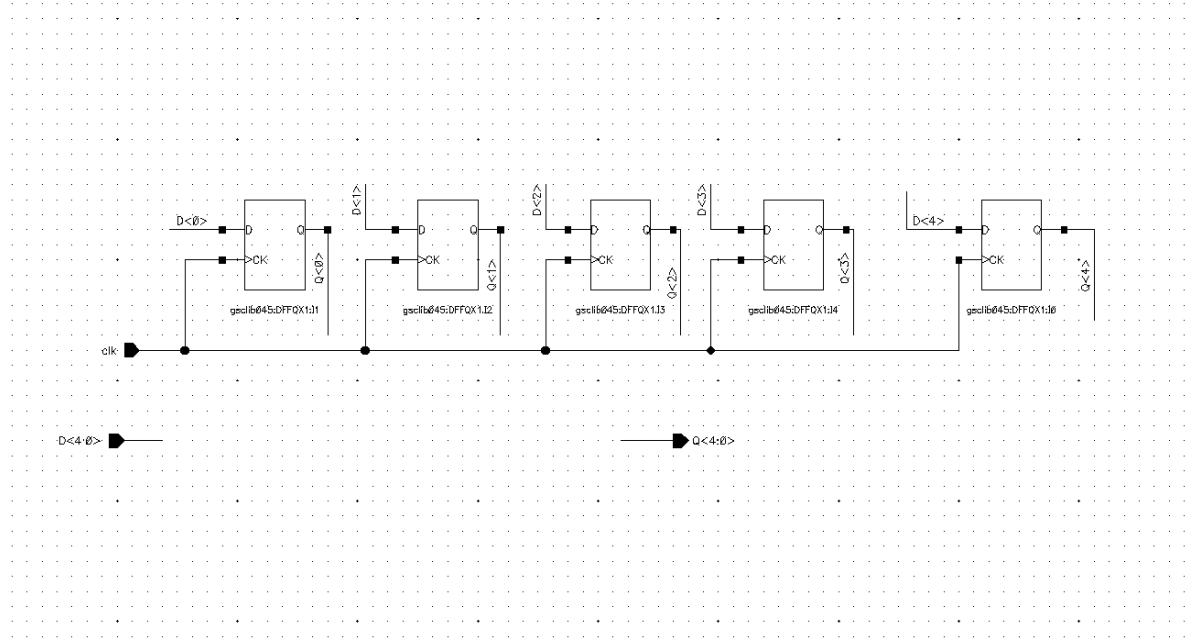


Figure 11: 5-bit register schematic

Layout Print

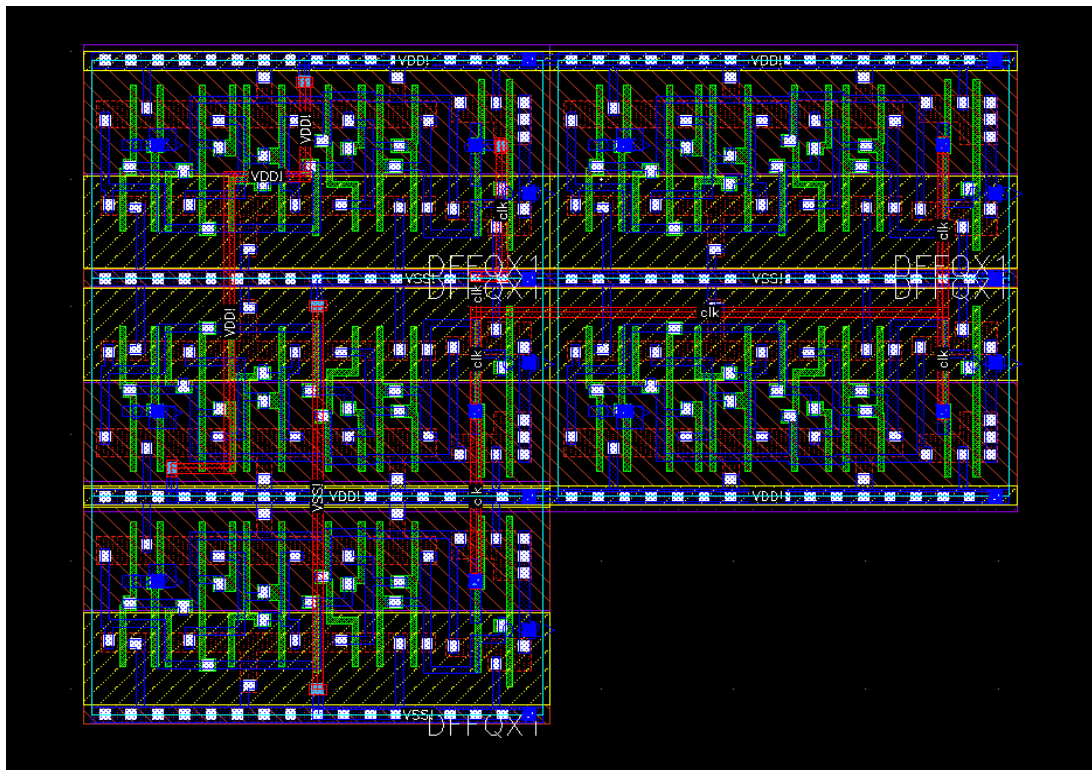


Figure 12: 5-bit register layout

4-bit XOR

Schematic Print

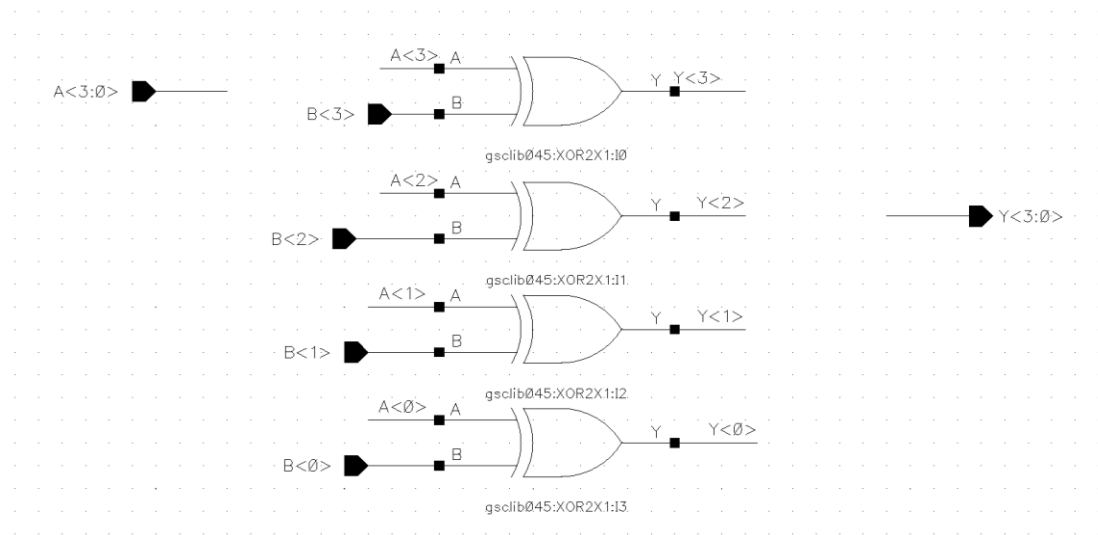


Figure 13: 4-bit XOR schematic

Layout Print

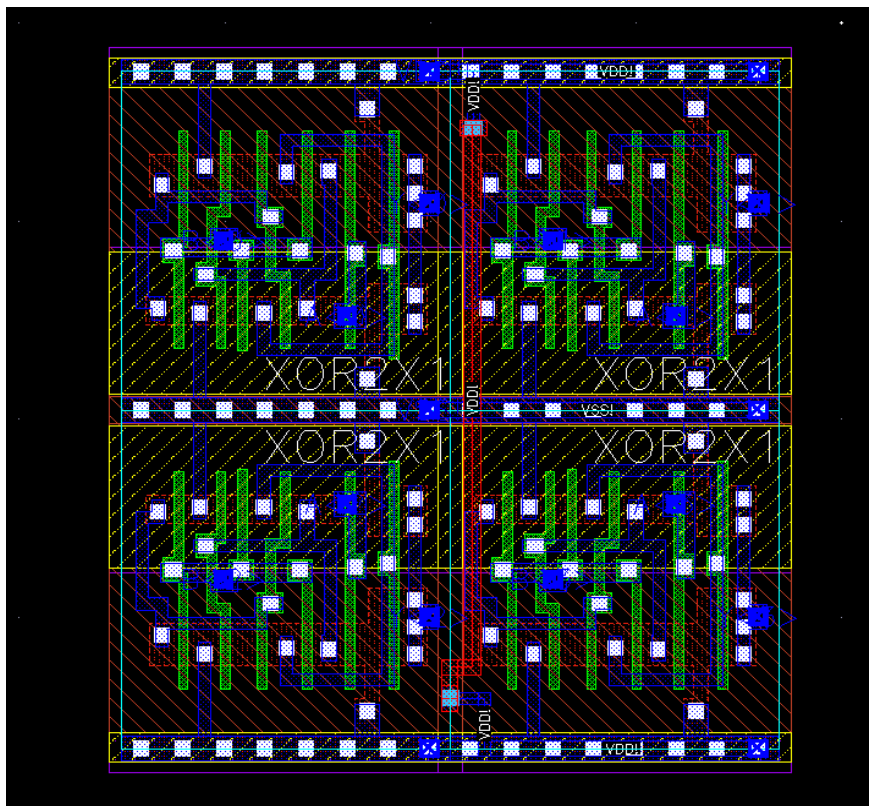


Figure 14: 4-bit XOR layout

Barrel Right-Shift register

Schematic Print

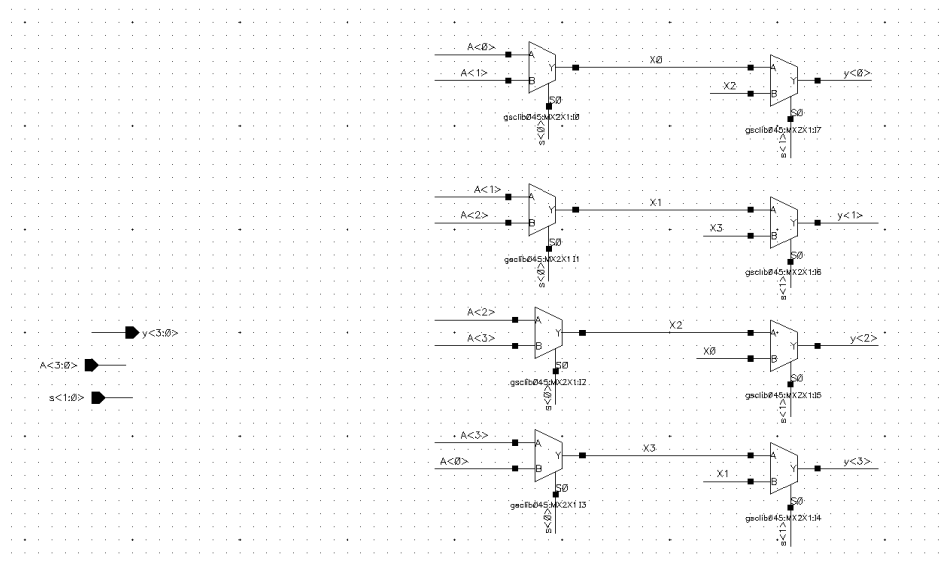


Figure 15: Barrel Shift Register schematic

Layout Print

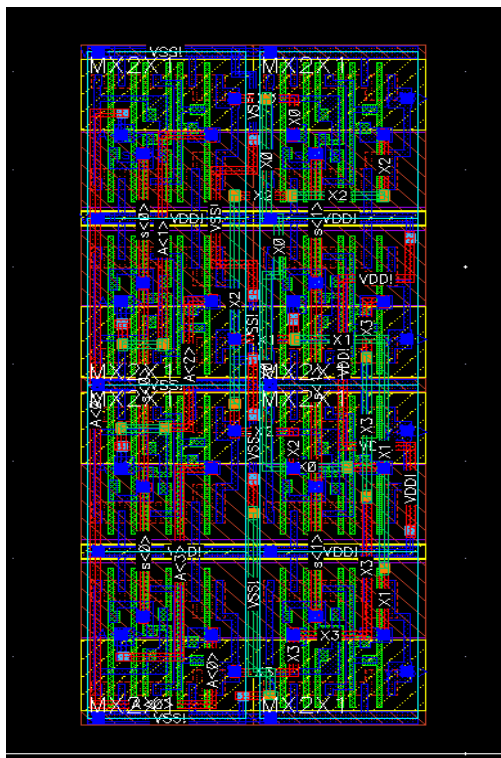


Figure 16: Barrel Shifter Layout

Adder block

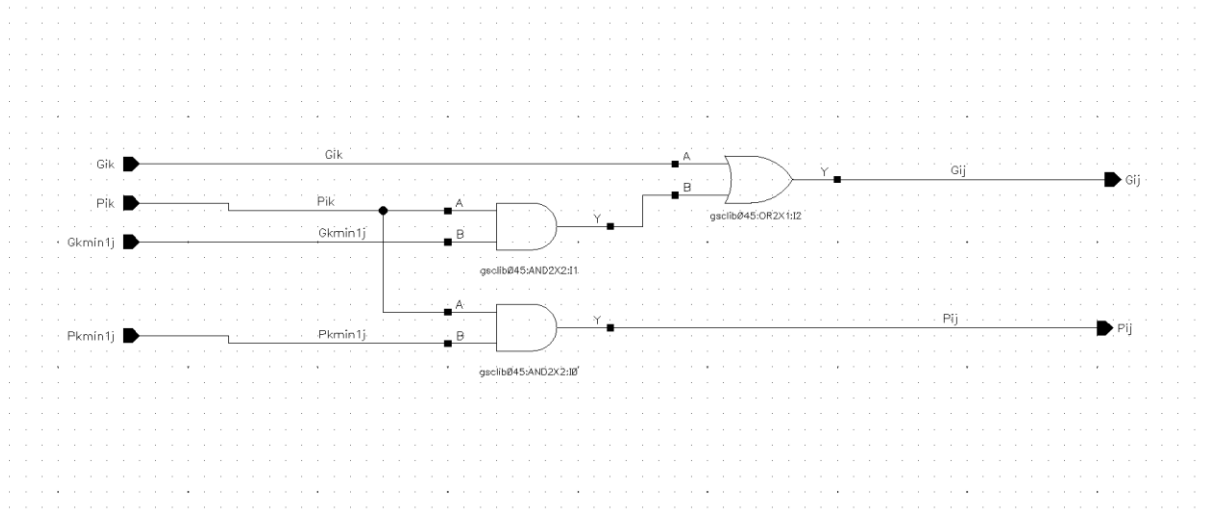


Figure 17: Black cell schematic

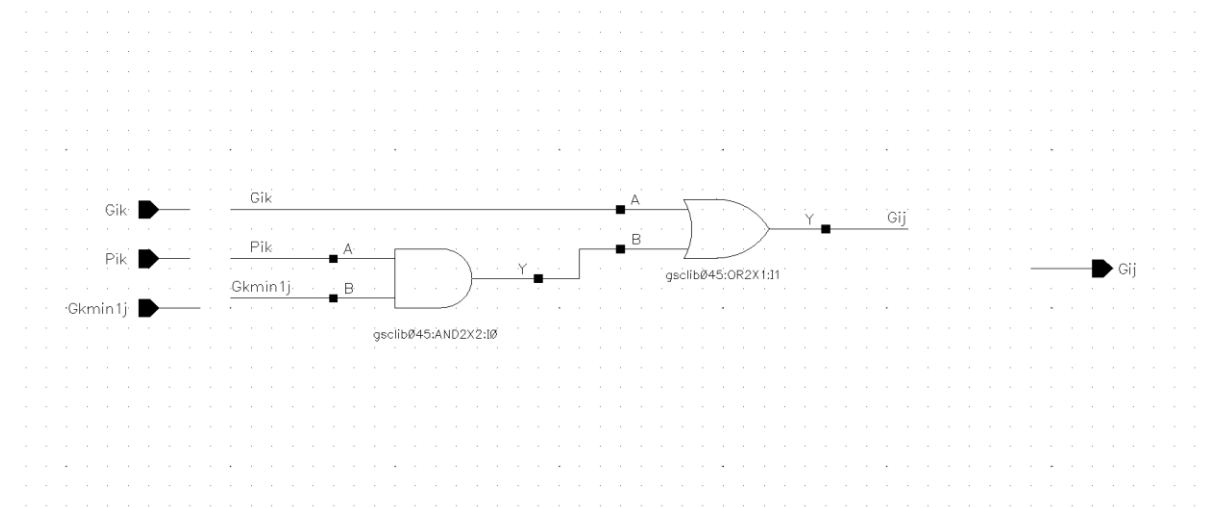


Figure 18: Grey cell schematic

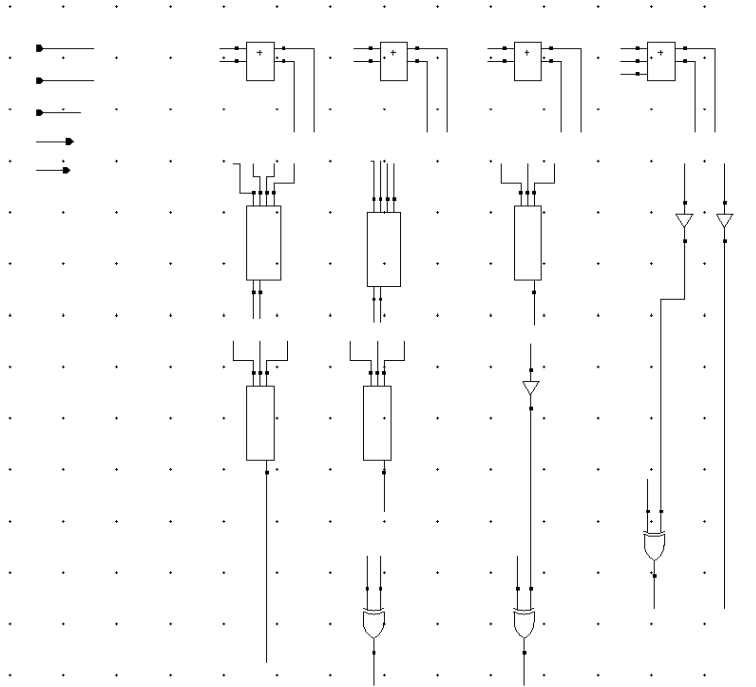


Figure 19: Adder schematic

Layout Print

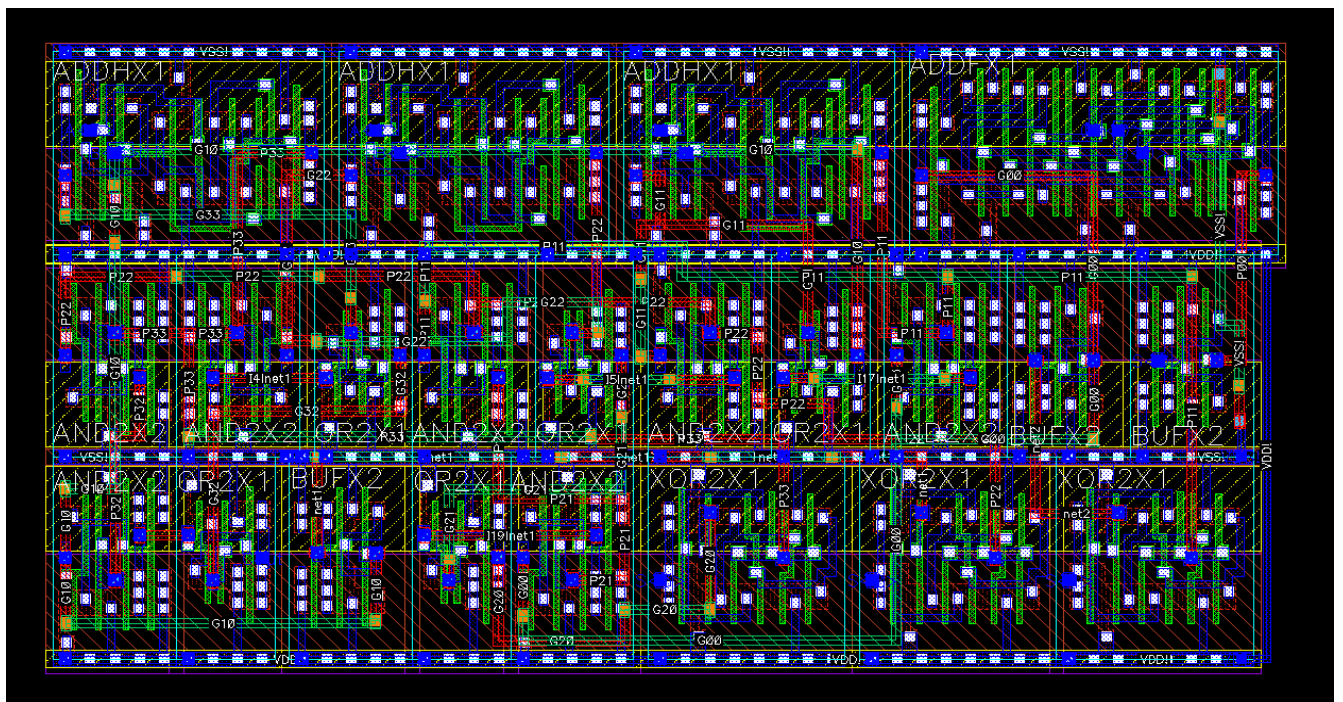


Figure 20: Adder layout

Schematic Print

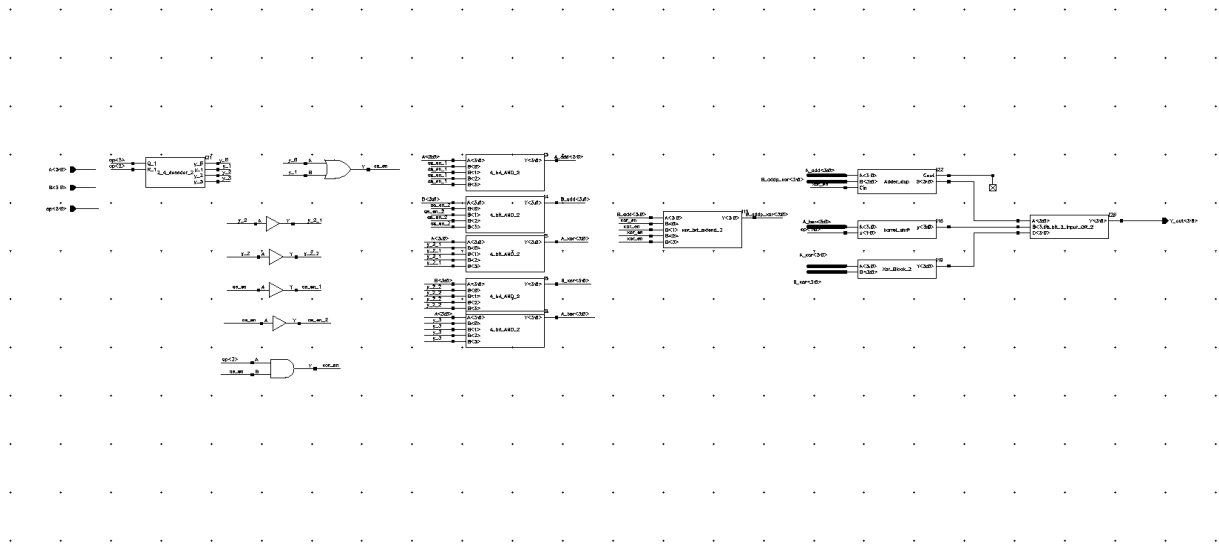


Figure 21: ALU schematic

Layout Print

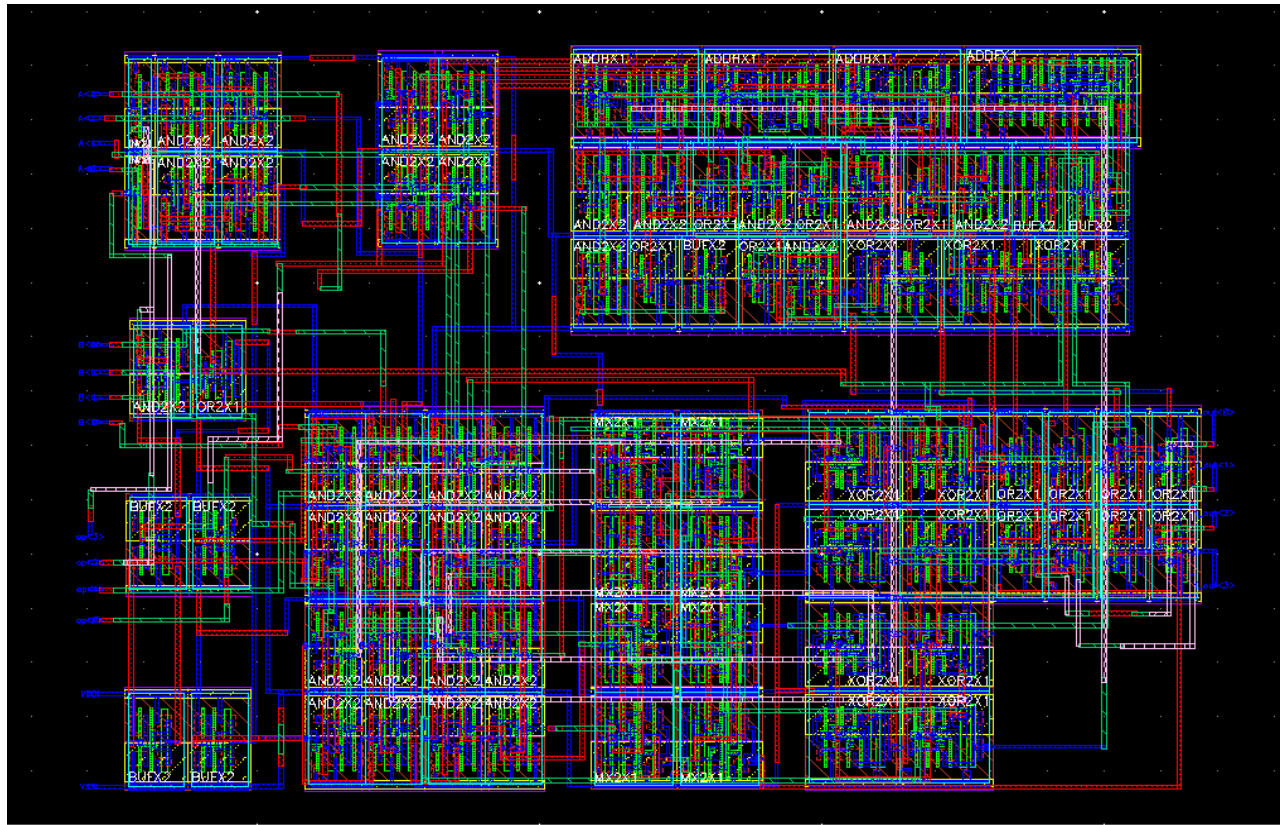


Figure 22: ALU layout

Overview circuit

Schematic Print

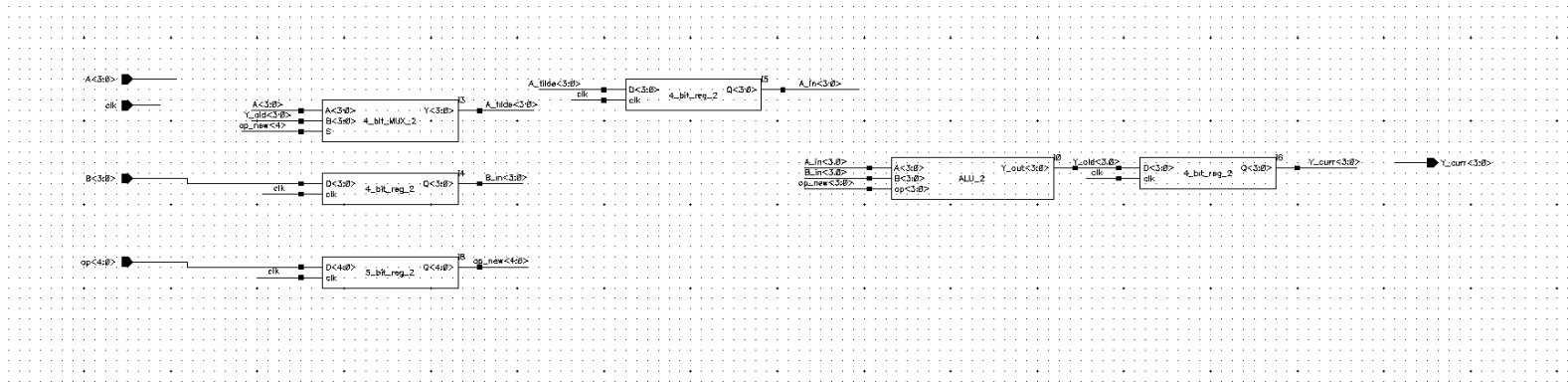


Figure 23: Overview circuit schematic

Layout Print

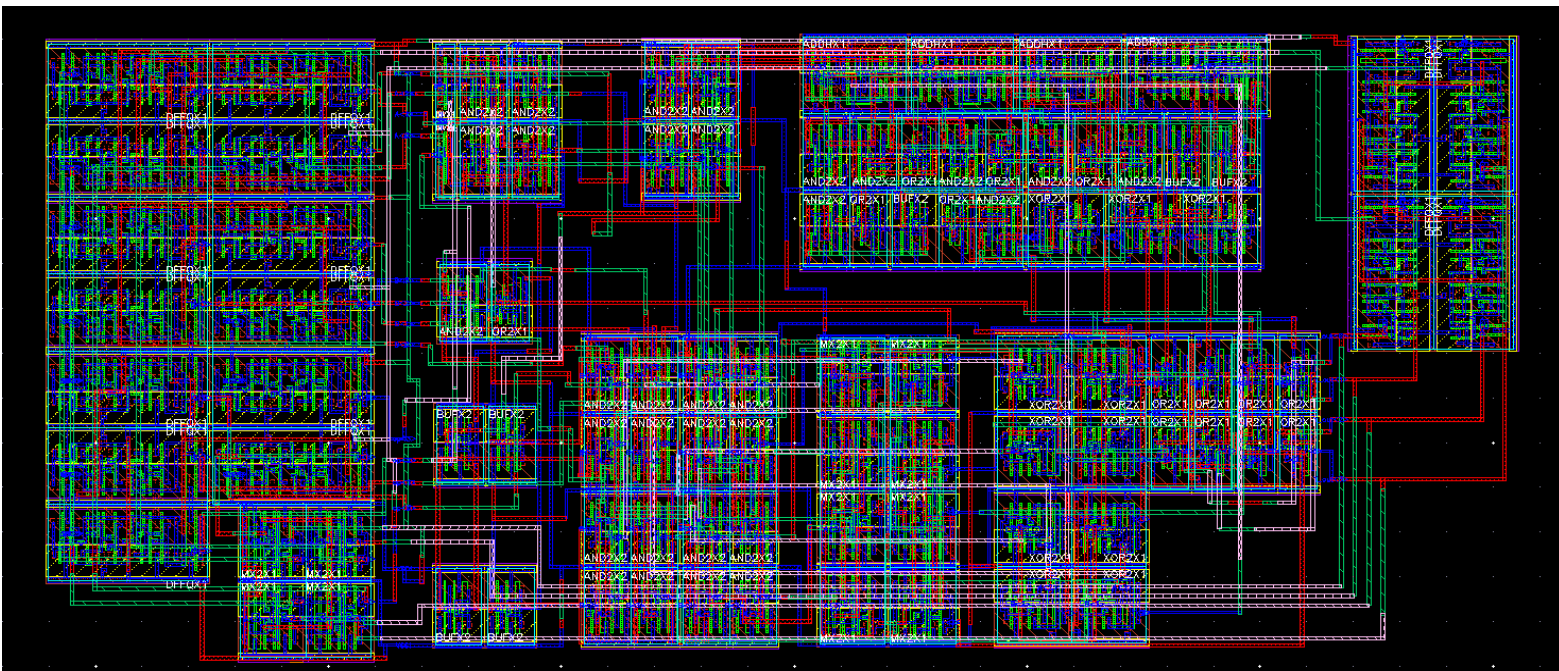


Figure 24: Overview circuit layout

Realization area

The final realization area is $31.615\mu m$ by $13.92\mu m = 440.0808 \mu m^2$ which is less than the projected area of $442.0992 \mu m^2$ which thus satisfies the constraint of the realization area not occupying more than 150% of the total area of the cells. In addition to this, only 4 layers of metal were used in the making of the final circuit with every individual block before the ALU using only 3 layers of metal at maximum.